



DIMENSIONS:(mm)

Sunltech





| Α | 4.5±0.2 |
|---|---------|
| В | 3.2±0.2 |
| С | 2.8±0.2 |
| D | 0.2±0.1 |
| E | 1.2TYP |
| F | 1.0TYP |

RECOMMENDED FOOTPRINT:(mm)





PACKING:

Quantity:500PCS/Reel



ELECTRICAL CHARACTERISTICS:

| P/N | Z(Ω) | | Rated Current | Rated Voltage | Insulation Resistance |
|----------------|-------------|---------|------------------|------------------|--------------------------|
| | Common Mode | DCR(32) | | | |
| | Impedance | [Max] | Idc(A) | Vdc | IR |
| | At 100MHz | | [Max] | (V)Typical | (mΩ)Min |
| SMW4532B801HTE | 800 | 0.12 | 1.0 | 50.0 | 10.0 |

Operating temperature: -25°C to +85°C
Storage temp and humidity: -40°C to +85°C 70%RH max
Typical heat rating DC current would cause an approximately ΔT of 40°C

◆ PERFORMANCE CURVES:







Test Equipment

Impedance

Measured by using Agilent 4291A RF Impedance Analyzer



DC Resistance Measured by using Chroma 16502 mill ohm meter



Insulation Resistance Measured by using Chroma 19073 Measurement voltage:50V Measurement time:60 sec





RECOMMENDED SOLDERING TEMP CRAPH:



• MECHANICAL RELIABILITY:

| TEST | Specification & R | lequirement | Method Used | |
|---------------------------|---|-------------|--|--|
| Solderability | The surface of terminal/pin tested shall be covered with new solder by 90% | | Solder heat proof Preheating: $150 \pm 10^{\circ}$ C 60 seconds Soldering: $245 \pm 5^{\circ}$ C for 4 ± 1 sec | |
| Solder Heat Resistance | Components should have not evidence of electrical and mechannical damage Impedance:within ±15% of initial value | | Preheating:150°C 60secs Solder temperature: 260±5°C Flux:rosin Dip time:10±0.5 secs | |
| Terminal strength | Series No | F (Kg) | Solder a chip to test substrate and then | |
| | 1608 | 0.5 | laterally apply a force in the arrow direction | |
| | 2012 | 0.5 | | |
| | 3216 | 1.0 | | |
| | 4532 | 1.0 | | |
| | | | Test Board | |



◆ ENDURANCE RELIABLITY:

| TEST | Specification & Requirement | Method Used | |
|------------------------|---|--|--|
| Thermal Shock | Impedance change within \pm 15% Without mechanical damage | -65°C, (30 mins) -> room temp. (2 mins) -> 125°C, (30 mins) -> room temp. (2 mins) 50 cycles | |
| Humidity Resistance | Impedance change within \pm 15% Without mechanical damage | Apply IDC current @ 60°C ambient Humidity: 90% Duration: 168 hrs | |
| Low Temp. Storing | Impedance change within ± 15% Without mechanical damage | Storing Temp. -40 \pm 2 °C for total 168 +5/-0 hours | |
| High Temp. Storing | Impedance change within ± 15% Without mechanical damage | Storing Temp. 125 \pm 2 °C for total 168 +5/-0 hours | |